



ENGINEERING DEPT.		PRODUCT SPECIFICATION	SPEC.NO.: SPCB038A
REVISIONS		For CB76 Connectors	PAGE: 1/4

1. SCOPE:

This specification contains the test requirement of subject connectors when tested under the condition and below standards base on CviLux test procedure

2. APPLICABLE STANDARDS:

MIL - STD - 202	Methods for test of connectors for electronic equipment
MIL - STD - 1344	Test methods for electrical connectors
J-STD-020	Resistance to soldering Temperature for through hole Mounted Devices
SS-00254	Test methods for electronic components ,LEAD-FREE soldering Part design standards

3. APPLICABLE SERIES NO.: **CB76 Series**

4. SHAPE, CONSTRUCTION AND DIMENSIONS

See attached drawings

5. MATERIALS

See attached drawings

6. ACCOMMODATED P.C.BOARD

0.8 mm (.031") ~ 1.6 mm (.063")



REVIEWED : David APPROVED : Eisley VERIFIED : Clark .

ENGINEERING DEPT.		PRODUCT SPECIFICATION	SPEC.NO.: SPCB038A
REVISIONS		For CB76 Connectors	PAGE: 2/4

7. ELECTRICAL PERFORMANCE:

	ITEM	TEST CONDITION	
7.1	Rated current and voltage		1A 250V AC (r.m.s.)
7.2	Contact resistance	Dry circuit of DC 20 mV max. 100mA max.	Less than 20 mΩ
7.3	Dielectric strength	When applied AC 1000 V 1 minute between adjacent terminal	No change
7.4	Insulation resistance	When applied DC 500 V between adjacent terminal or ground	More than 1000 MΩ

8. MECHANICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
8.1	Contact retaining force in insulator	Retention speed 25± 3 mm per minute form housing	More than 400 gram
8.2	Single contact insertion force	Measure force to insertion using 0.50 mm square pin at speed 25± 3 mm per minute	600 gram max.
8.3	Single contact withdrawal force	Measure force to withdrawal using 0.50 mm square pin at speed 25± 3 mm per minute	20 gram min.
8.4	Durability	Connector shall be subjected to 50 cycles of insertion and withdrawal	Contact resistance: Less than twice of initial

9. ENVIRONMENTAL PERFORMANCE:

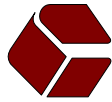
	ITEM	TEST CONDITION	REQUIREMENT
9.1	Temperature rise	Then carried the rated current	30°C max.
9.2	Vibration	1.5 mm 10 - 55 - 10 HZ/minute each 2 hours for X,Y and Z directions	Appearance: No damage Discontinuity: 1 micro second max.
9.3	Solderability	Lead-Free Process: Soldering time: 3 ± 0.5 second Soldering pot: 245 ± 5°C	Minimum: 95% of immersed area



ENGINEERING DEPT.		PRODUCT SPECIFICATION	SPEC.NO.: SPCB038A
REVISIONS		For CB76 Connectors	PAGE: 3/4

	ITEM	TEST CONDITION	REQUIREMENT
9.4	Resistance to soldering heat	SMT Type Lead-Free Process: Soldering time: 20 second Max. Soldering pot: 250~260°C Refer Reflow temperature profile(11.1)	No damage
9.5	Heat aging	105± 2°C, 96 hours	No damage
9.6	Humidity	40±2°C, 90-95% RH, 96 hours measurement must be taken within 30 min. after tested	Appearance: No damage Contact resistance: Less than twice of initial Dielectric strength: To pass para 7-3
9.7	Temperature cycling	One cycle consists of : (1) -55 ⁺⁰ ₋₃ °C , 30 min. (2)Room temp. 10-15 min. (3) 85 ⁺³ ₋₀ °C , 30 min. (4)Room temp. 10-15 min. Total cycle: 5 cycle	Appearance: No damage Contact resistance: Less than twice of initial Dielectric strength: To pass para 7-3
9.8	Salt spray	Temperature: 35± 3°C Solution: 5± 1% Spray time: 48± 4 hours Measurement must be taken after water rinse	Appearance: No damage Contact resistance: Less than twice of initial Dielectric strength: To pass para 7-3

10. AMBIENT TEMPERATURE RANGE: -40 to + 105°C



ENGINEERING DEPT.		PRODUCT SPECIFICATION	SPEC.NO.: SPCB038A
REVISIONS		For CB76 Connectors	PAGE: 4/4

11. Recommended IR Reflow Temperature Profile:

11.1 Using Lead-Free Solder Paste

